

### **NCE N-Channel Super Trench Power MOSFET**

#### **Description**

The NCEP1520AK uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{\text{DS}(\text{ON})}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

#### **General Features**

• V<sub>DS</sub> =150V,I<sub>D</sub> =20A

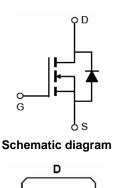
 $R_{DS(ON)}$ =56m $\Omega$  (typical) @  $V_{GS}$ =10V  $R_{DS(ON)}$ =68m $\Omega$  (typical) @  $V_{GS}$ =4.5V

- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

#### **Application**

- LED backlighting
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED!





Marking and pin assignment



TO-252 -2Ltop view

**Package Marking and Ordering Information** 

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP1520AK	NCEP1520AK	TO-252-2L	Ø330mm	12mm	2500 units

### Absolute Maximum Ratings (T<sub>A</sub>=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	150	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current-Continuous	I <sub>D</sub>	20	А
Drain Current-Continuous(T <sub>C</sub> =100 °C)	I <sub>D</sub> (100℃)	14	А
Pulsed Drain Current	I <sub>DM</sub>	80	Α
Maximum Power Dissipation	P <sub>D</sub>	68	W
Derating factor		0.45	W/°C
Drain Source voltage slope, V <sub>DS</sub> ≤150 V	dv/dt	50	V/ns
Reverse diode dv/dt, V <sub>DS</sub> ≤150 V, I <sub>SD</sub> <i<sub>D</i<sub>	dv/dt	10	V/ns
Single pulse avalanche energy (Note 5)	Eas	30	mJ
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55 To 175	$^{\circ}$



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# NCEP1520AK

### **Thermal Characteristic**

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	R <sub>0JC</sub>	2.2	°C/W

Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics	<u>.</u>		•	•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	150	-	-	V	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =150V,V <sub>GS</sub> =0V	-	-	1	μA	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA	
On Characteristics (Note 3)	<u>.</u>		•	•			
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_D=250\mu A$	1.3	1.9	2.5	V	
5 . 6 . 6 . 6	В	V <sub>GS</sub> =10V, I <sub>D</sub> =10A	-	56	62	0	
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A		68	82	mΩ	
Gate resistance	R <sub>G</sub>		-	10	-	Ω	
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =10A	-	15	-	S	
Dynamic Characteristics (Note4)	·						
Input Capacitance	C <sub>lss</sub>	\/ 75\/\\ 0\/	-	799		PF	
Output Capacitance	Coss	$V_{DS}$ =75 $V$ , $V_{GS}$ =0 $V$ , F=1.0MHz	-	74.4		PF	
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.UIVITZ	-	11.1		PF	
Switching Characteristics (Note 4)			•				
Turn-on Delay Time	t <sub>d(on)</sub>		-	10.5	-	nS	
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =75 $V$ , $R_L$ =7.5 $\Omega$	-	6	-	nS	
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{G}$ =3 $\Omega$	-	14.5	-	nS	
Turn-Off Fall Time	t <sub>f</sub>		-	3.5	-	nS	
Total Gate Charge	Qg	\/ -75\/  -404	-	15	-	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}=75V,I_{D}=10A,$	-	4.5	-	nC	
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	3	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =10A	-	-	1.2	V	
Diode Forward Current (Note 2)	Is		-	-	20	Α	
Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25^{\circ}C, I_F = I_S$	-	29.5	-	nS	
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	132	-	nC	

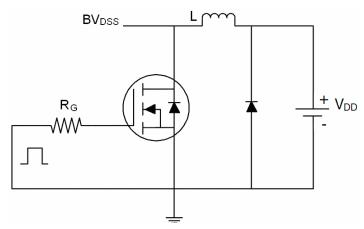
#### Notes:

- ${\bf 1.}\ {\bf Repetitive}\ {\bf Rating:}\ {\bf Pulse}\ {\bf width}\ {\bf limited}\ {\bf by}\ {\bf maximum}\ {\bf junction}\ {\bf temperature}.$
- 2. Surface Mounted on FR4 Board,  $t \le 10$  sec.
- 3. Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25  $^{\circ}$ C,V<sub>DD</sub>=50V,V<sub>G</sub>=10V,L=0.5mH,Rg=25 $\Omega$

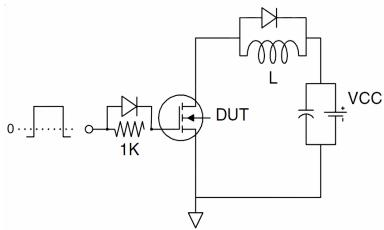


### **Test Circuit**

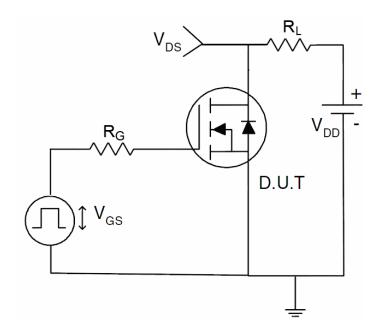
### 1) E<sub>AS</sub> test Circuit



### 2) Gate charge test Circuit

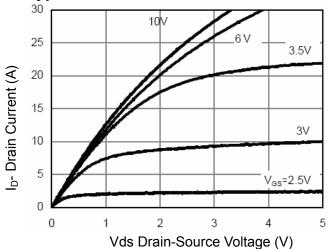


### 3) Switch Time Test Circuit

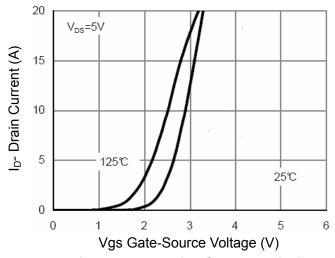




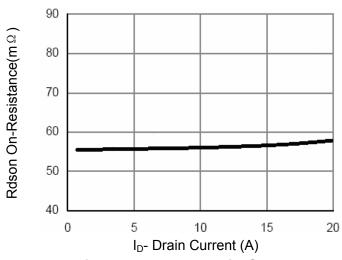
### **Typical Electrical and Thermal Characteristics**



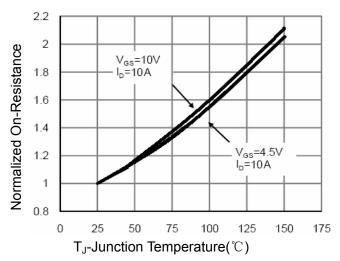
**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 



**Figure 3 Rdson- Drain Current** 



**Figure 4 Rdson-Junction Temperature** 

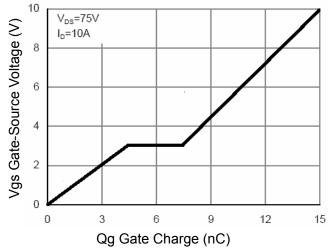


Figure 5 Gate Charge

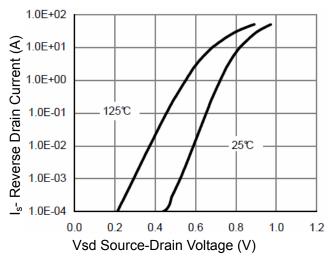


Figure 6 Source- Drain Diode Forward



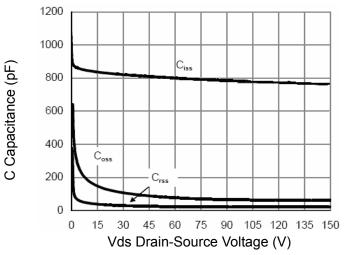


Figure 7 Capacitance vs Vds

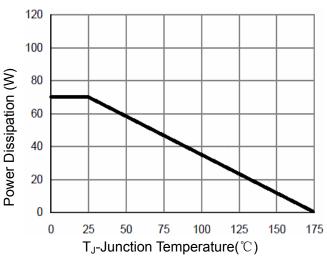
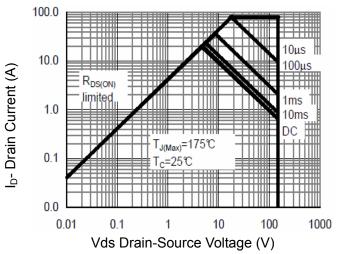


Figure 9 Power De-rating



**Figure 8 Safe Operation Area** 

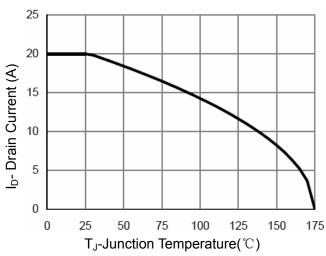
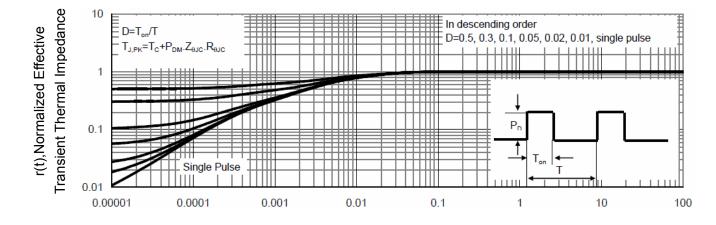


Figure 10 Current De-rating

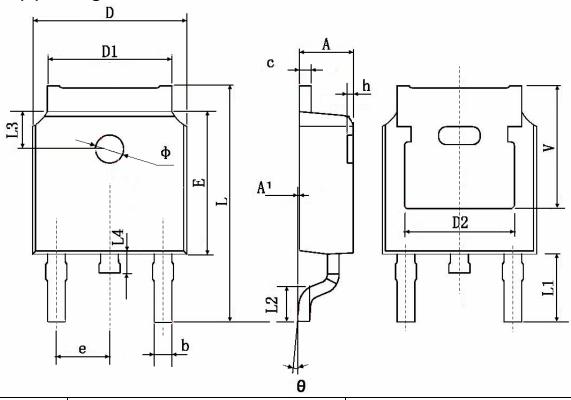


Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



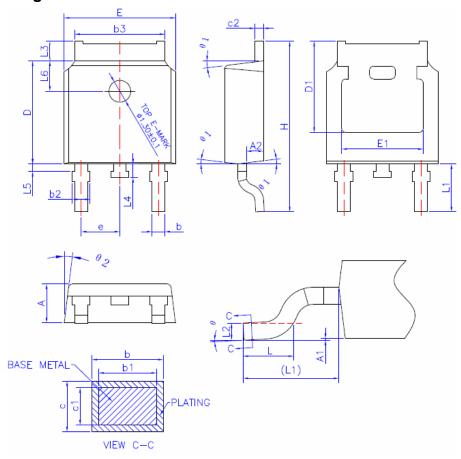
# TO-252-2L (C) Package Information



Cumbal	Dimensions	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.83	4.83 TYP.		TYP.	
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900	TYP.	0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600	1.600 TYP.		TYP.	
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350	TYP.	0.211	TYP.	



### TO-252-2L (P) Package Information



#### COMMON DIMENSIONS (UNITS OF MEASURE =MILLIMETER)

SYMBOL	MIN	NOM	MAX	
Α	2,20	2,30	2,38	
A1	0	_	0.10	
A2	0.90	1.01	1,10	
b	0.72	_	0.85	
b1	0.71	0.76	0.81	
b2	0,72	_	0,90	
b3	5.13	5.33	5.46	
С	0.47	_	0,60	
c1	0.46	0.51	0,56	
c2	0.47	_	0.60	
D	6,00	6.10	6,20	
D1	5,25	_	_	
E	6.50	6.60	6.70	
E1	4,70	_	_	
e	2,186	2,286	2,386	
Н	9.80	10.10	10.40	
L	1,40	1.50	1,70	
L1		2.90 REF		
L2	0.508 BSC			
L3	0,90	_	1,25	
L4	0.60	0.80	1.00	
L5	0.15	_	0.75	
L6	1,80 REF			
θ	0°	_	8°	
θ1	5°	7°	9°	
θ2	5°	7°	9°	

ALL DIMENSIONS REFER TO JEDEC STANDARED TO-252 AA DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS

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# NCEP1520AK

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